



## DMJ70H1D4SV3

#### **N-CHANNEL ENHANCEMENT MODE MOSFET**

## **Product Summary**

BV <sub>DSS</sub>	RDS(ON) Max	I <sub>D</sub> T <sub>C</sub> = +25°C	
700V	$1.5\Omega @ V_{GS} = 10V$	5.0A	

### **Features and Benefits**

- Low On-Resistance
- High BV<sub>DSS</sub> Rating for Power Application
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

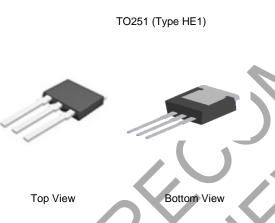
## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

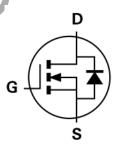
- Adaptor
- LCD & PDP TV
- Lighting

### **Mechanical Data**

- Case: TO251 (Type HE1)
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208@3
- Weight: 0.33 grams (Approximate)







Top View Pin Configuration

Internal Schematic

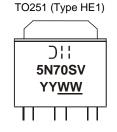
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMJ70H1D4SV3	TO251 (Type HE1)	75 Pieces / Tube

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and
- <1000ppm antimony compounds.</p>
  4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**





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# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	700	V
Gate-Source Voltage		V <sub>GSS</sub>	±30	V
Continuous Drain Current (Note 5) V <sub>GS</sub> = 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I <sub>D</sub>	5.0 3.2	А
Maximum Body Diode Forward Current (Note 6)	·	Is	3.5	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	6.0	Α
Avalanche Current (Note 7)	L = 60mH	I <sub>AS</sub>	0.5	Α
Avalanche Energy (Note 7)	L = 60mH	E <sub>AS</sub>	7.5	mJ
Peak Diode Recovery dv/dt (Note 7)		dv/dt	6	V/ns

# **Thermal Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_C = +25^{\circ}C$ $T_C = +100^{\circ}C$	PD	78 31	W
Thermal Resistance, Junction to Ambient (Note 6)		$R_{\theta JA}$	78	°C/W
Thermal Resistance, Junction to Case (Note 5)		R <sub>θJC</sub>	1.8	C/VV
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

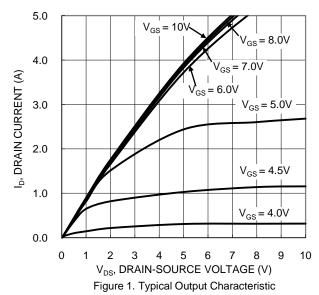
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	700	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	<b>\</b> -	1	μA	V <sub>DS</sub> = 700V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	-	7	100	nA	$V_{GS} = \pm 30V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	2	3.4	4	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	<b>/</b>	1.2	1.5	Ω	$V_{GS} = 10V, I_D = 1A$	
Diode Forward Voltage	$V_{SD}$		0.85	1.3	V	V <sub>GS</sub> = 0V, I <sub>S</sub> =1A	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	C <sub>iss</sub>	<u> </u>	342	_		V 50V t 1ML	
Output Capacitance	$C_{oss}$	_	65	_	pF	$V_{DS} = 50V, f = 1MHz,$	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	0.5	_		$V_{GS} = 0V$	
Gate Resistance	R <sub>G</sub>	_	4.1	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	7.5	_		V <sub>DD</sub> = 560V, I <sub>D</sub> = 3.2A,	
Gate-Source Charge	Q <sub>gs</sub>	_	1.7	_	nC		
Gate-Drain Charge	Q <sub>gd</sub>	_	3.0	_		$V_{GS} = 10V$	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	8	_		$V_{DD} = 350V, V_{GS} = 10V,$ $R_G = 4.7\Omega, I_D = 3.2A$	
Turn-On Rise Time	t <sub>R</sub>	_	9	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	22	_	115		
Turn-Off Fall Time	t <sub>F</sub>		5	_		<u> </u>	
Body Diode Reverse Recovery Time	$t_{RR}$		178	_	ns	1 2 2 A dl/dt 400 A / v c	
Body Diode Reverse Recovery Time (T <sub>J</sub> = +150°C)	t <sub>RR</sub>	_	223	_	ns		
Body Diode Reverse Recovery Charge	$Q_{RR}$	_	1.3	_	μC	$I_S = 3.2A$ , $dI/dt = 100A/\mu s$	
Body Diode Reverse Recovery Charge (T <sub>J</sub> = +150°C)	Q <sub>RR</sub>	_	1.8	_	μC		

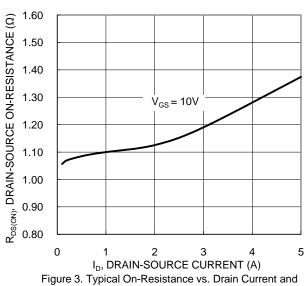
Notes:

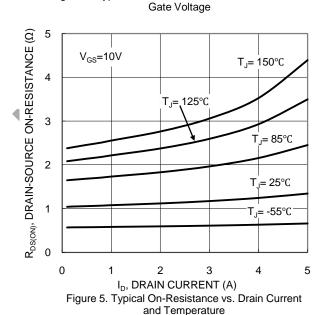
- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.
- S. Device mounted on FR-4 substrate PC board, 20z. copper, with minimum recommended pad layout.
   Guaranteed by design. Not subject to production testing.
   Short duration pulse test used to minimize self-heating effect.



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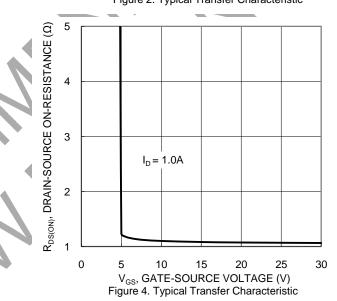








3 V<sub>DS</sub>= 10V 2.5 I<sub>D</sub>, DRAIN CURRENT (A) 2 1.5 1 \_= 85°C  $T_{J} = 150^{\circ}C$ 0.5 = 25°C  $T_{J} = 125^{\circ}$ = -55°C 0 0 2 3 4 5 6 V<sub>GS</sub>, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic



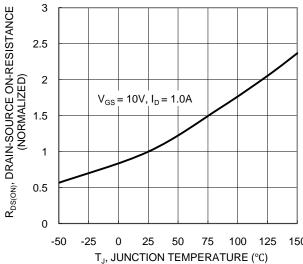


Figure 6. On-Resistance Variation with Temperature

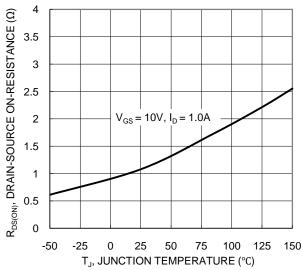
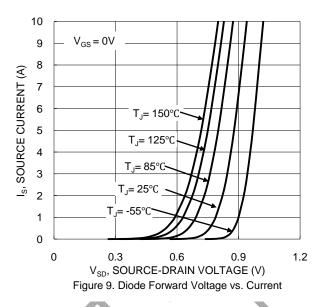
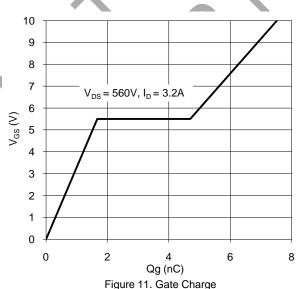


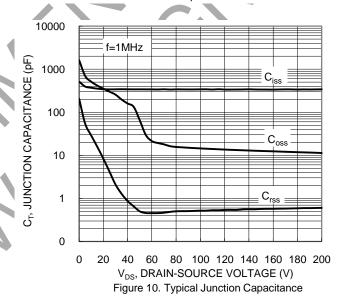
Figure 7. On-Resistance Variation with Temperature

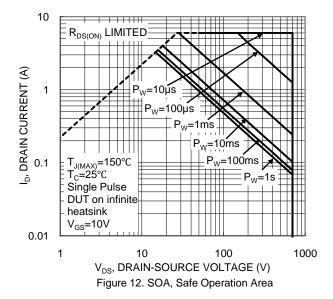




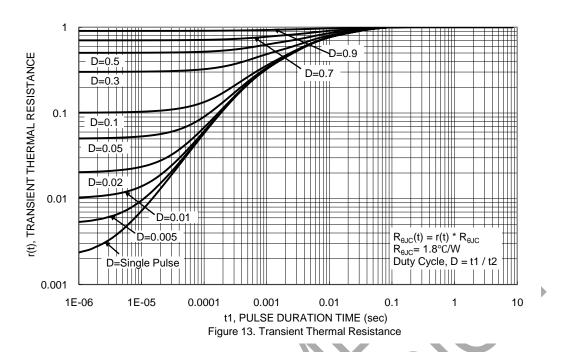
5  $V_{\text{GS(TH)}}, \text{ GATE THRESHOLD VOLTAGE (V)}$ 4  $I_D = 1mA$ 3  $I_{D} = 250 \mu A$ 2 0 -25 -50 0 25 50 75 100 125 150 T<sub>.</sub>I, JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. Junction Temperature



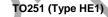


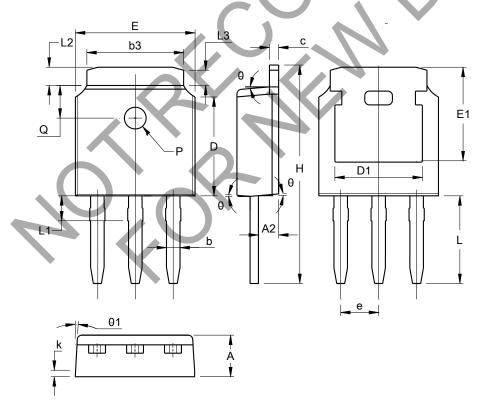




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.





TO251 (Type HE1)					
Dim	Min	Max	Тур		
Α	2.20	2.40	2.30		
A2	0.97	1.17	1.07		
b	0.68	0.90	0.78		
b3	5.20	5.50	5.33		
C	0.43	0.63	0.53		
D	5.98	6.22	6.10		
D1	5	.30 RE	F		
е	2.	286 BS	Ö		
Е	6.40	6.80	6.60		
E1	4.63	5.03	4.83		
H	10.00	11.44	11.22		
k	(	).40REI			
L	3.90	4.30	4.10		
L1	0.85	1.25	1.05		
L2	0.88	1.28	1.02		
L3	0.75 REF				
ø	1.65	1.95	1.80		
ΡØ	1.20				
θ	5°	9°	7°		
θ1	5°	9°	7°		
All Dimensions in mm					



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